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### **Application Information**

Title Line One:: Thin Film Patterning Substrate And  
Title Line Two:: Surface Treatment Therefor  
Title Line Three::  
Title Line Four::

Total Drawing Sheets:: 24  
Docket Number:: 104741

**Continuity Information**

>This application is a:: U.S. National Stage of  
Application One:: PCT/JP99/01327  
Filing Date:: March 17, 1999  
Patent Number::  
which is a::  
>>Application Two::  
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**Prior Foreign Applications**

Foreign Application One:: 10-67508  
Filing Date:: March 17, 1998  
Country:: Japan  
Priority Claimed:: yes  
Foreign Application Two:: 11-32123  
Filing Date:: February 10, 1999  
Country:: Japan  
Priority Claimed:: yes  
Foreign Application Three::  
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Country::  
Priority Claimed::